AMBROMETALS:

ETP COPPER (UNS C11000) SPECIFICATION & DATASHEET

ALLOY CHARACTERISTICS

Cu-ETP is an oxygen containing copper which has high electrical and thermal conductivity. It also has excellent forming properties. Due to its oxygen content soldering and welding properties are limited. Main applications: Automotive Radiators, Electrical connectors, Transformer Strips, Switches, Terminals, Contacts, Connectors, Busbars, Terminal Connectors, Conductors, Cable Strips Industrial, Printed circuit boards, Stamped parts, Pressure Vessels, Chemical Process Equipment, Heat Exchangers, Heat sinks, Printing Rolls, Anodes, Rotating Bands, Kettles, Pans & Vats.

ALLOY PURITY

99.9% Copper.

MECHANICAL PROPERTIES

PROPERTY	UNITS
Half Hard Temper	HV 65-95
Tensile Strength	240-300 N/mm ²
Elongation	Min. 14%

PHYSICAL PROPERTIES

PROPERTY	UNITS
Melting Point (Liquidus)	Approx. 1083° C
Density	8.93 gm/cm³@20°C
Coefficient of Thermal Expansion	17.7 x 10 ⁻⁶ /°K (20°C)
Electrical Conductivity	Min. 98% IACS
Thermal Conductivity	388 W/m.K @ 20°

SIMILAR SPECIFICATIONS

- o EN Cu-ETP
- o DIN CW004A
- o JIS C1100
- o ASTM C11000

